

## Product Summary

Symbol	Value	Unit
$I_{T(RMS)}$	40	A
$V_{DRM} / V_{RRM}$	800/1200/1600	V
$V_{TM}$	1.55	V

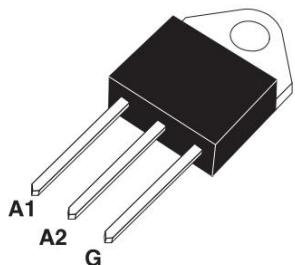
## Feature

With high ability to withstand the shock loading of large current, With high commutation performances, 3 quadrants products especially recommended for use on inductive load.

## Application

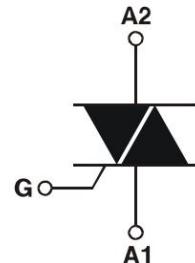
Washing machine, vacuums, massager, solid state relay, AC Motor speed regulation and so on.

## Package

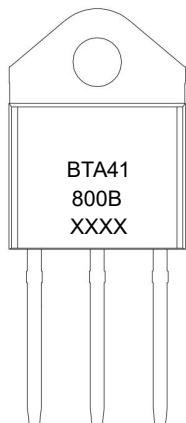


TO-3P Insulated

## Circuit diagram



## Marking



**Absolute maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Repetitive peak off-state voltage	V <sub>DRM</sub>	800/1200/1600	V
Repetitive peak reverse voltage	V <sub>RRM</sub>	800/1200/1600	V
RMS on-state current	I <sub>T(RMS)</sub>	40	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)	I <sub>TSM</sub>	400	A
I <sup>2</sup> t value for fusing (tp=10ms)	I <sup>2</sup> t	880	A <sup>2</sup> s
Critical rate of rise of on-state current (I <sub>G</sub> =2×I <sub>GT</sub> )	dI/dt	50	A/μs
Peak gate current	I <sub>GM</sub>	4	A
Average gate power dissipation	P <sub>G(AV)</sub>	1	W
Junction Temperature	T <sub>J</sub>	-40 ~ +125	°C
Storage Temperature	T <sub>STG</sub>	-40 ~ +150	°C

**Electrical characteristics (T<sub>A</sub>=25 °C, unless otherwise noted)**

Parameter	Symbol	Test Condition		Value		Unit
Gate trigger current	I <sub>GT</sub>	V <sub>D</sub> =12V R <sub>L</sub> = 33Ω	I - II - III	MAX.	50	mA
Gate trigger voltage	V <sub>GT</sub>		I - II - III	MAX.	1.3	V
Gate non-trigger voltage	V <sub>GD</sub>	V <sub>D</sub> =V <sub>DRM</sub> T <sub>j</sub> =125 °C R <sub>L</sub> =3.3KΩ	I - II - III	MIN.	0.2	V
latching current	I <sub>L</sub>	I <sub>G</sub> =1.2I <sub>GT</sub>	I - III	MAX.	80	mA
			II		100	
Holding current	I <sub>H</sub>	I <sub>T</sub> =100mA		MAX.	60	mA
Critical-rate of rise of commutation voltage	dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =125°C		MIN.	1000	V/μs
<b>STATIC CHARACTERISTICS</b>						
Forward "on" voltage	V <sub>TM</sub>	I <sub>TM</sub> =60A tp=380μs		MAX.	1.55	V
Repetitive Peak Off-State Current	I <sub>DRM</sub>	V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub>	T <sub>j</sub> =25°C	MAX.	10	μA
Repetitive Peak Reverse Current	I <sub>RRM</sub>		T <sub>j</sub> =125°C	MAX.	5	mA
<b>THERMAL RESISTANCES</b>						
Thermal resistance	R <sub>th(j-c)</sub>	Junction to case(AC)		TYP.	0.9	°C/W
	R <sub>th(j-a)</sub>	Junction to ambient		TYP.	50	°C/W

## Typical Characteristics

FIG.1: Maximum power dissipation versus RMS on-state current (full cycle)

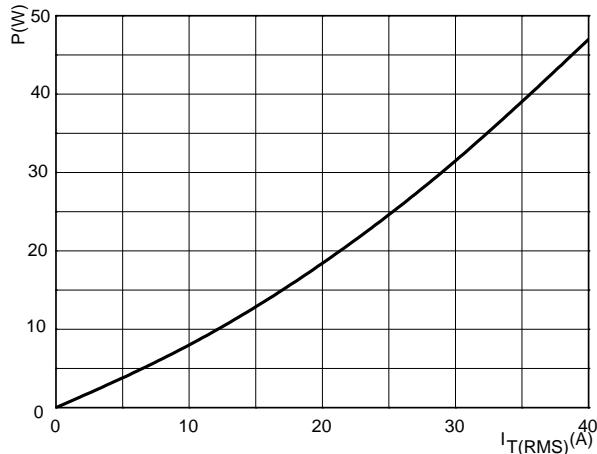


FIG.2: RMS on-state current versus case temperature (full cycle)

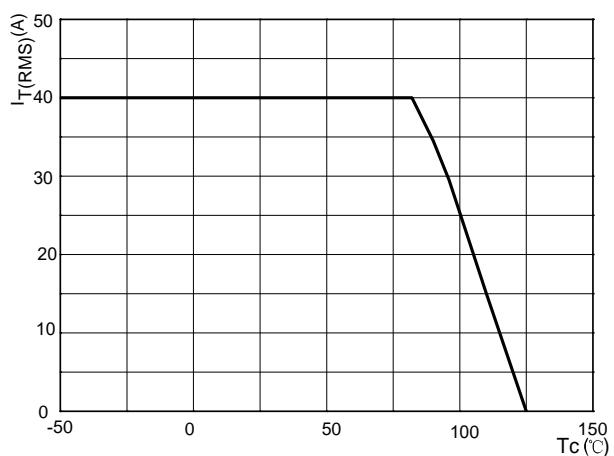


FIG.3: Surge peak on-state current versus number of cycles

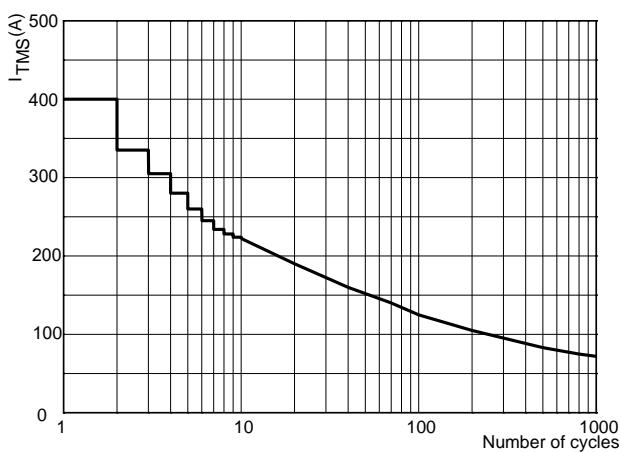


FIG.4: On-state characteristics (maximum values)

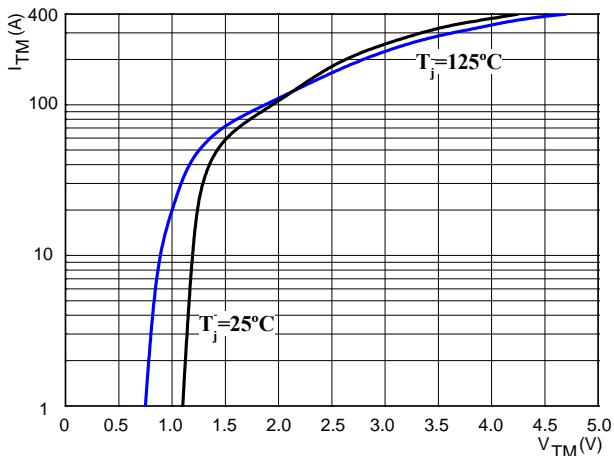


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp < 10ms

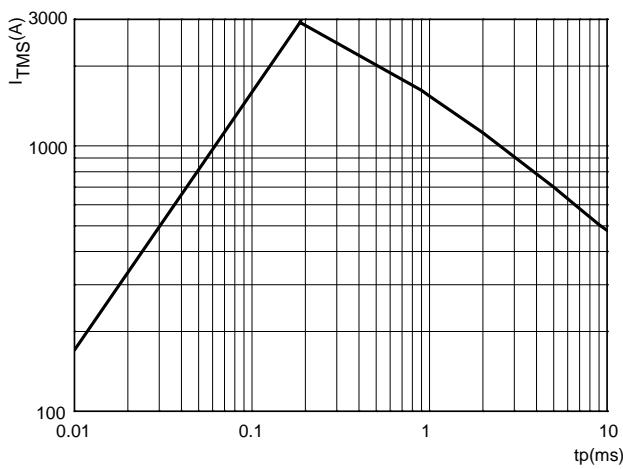
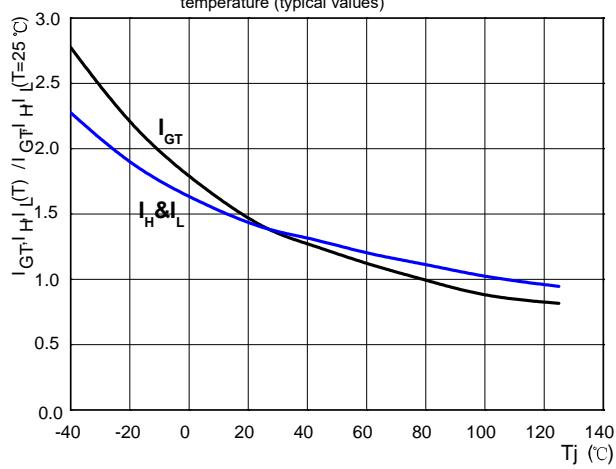
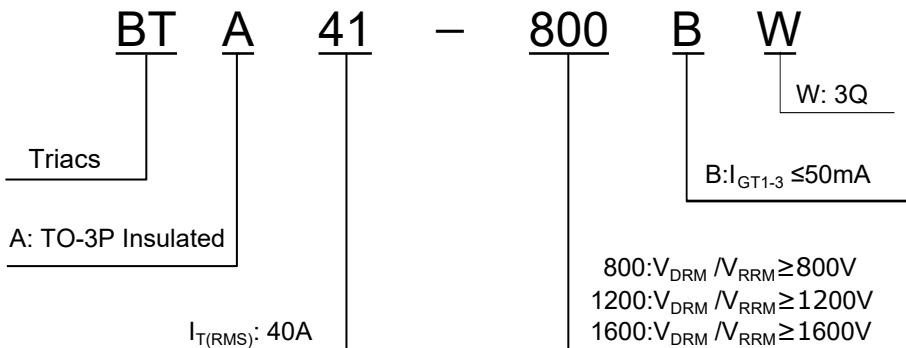
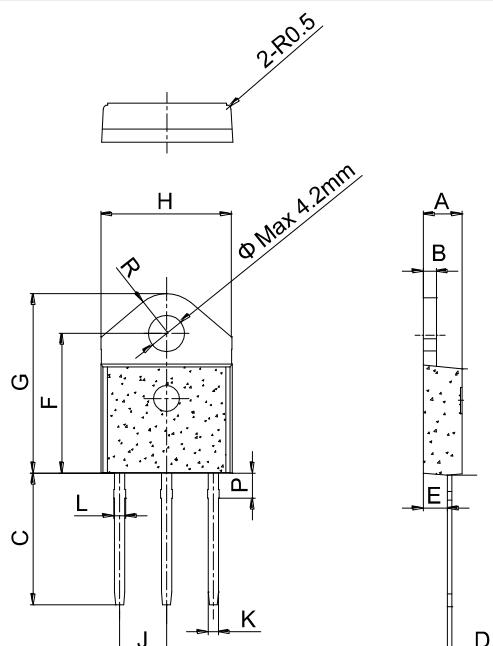


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature (typical values)



**Ordering Information**

**TO-3P Insulated Package Information**


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	1.45		1.55	0.057		0.061
C	14.35		15.60	0.565		0.614
D	0.50		0.70	0.020		0.028
E	2.70		2.90	0.106		0.114
F	15.80		16.50	0.622		0.650
G	20.40		21.10	0.803		0.831
H	15.10		15.50	0.594		0.610
J	5.40		5.65	0.213		0.222
K	1.10		1.40	0.043		0.055
L	1.35		1.50	0.053		0.059
P	2.80		3.00	0.110		0.118
R		4.35			0.171	